# **Specification of Thermoelectric Module**

## **TEC1-12705**

### Description

The 127 couples, 40 mm  $\times$  40 mm size single module which is made of our high performance ingot to achieve superior cooling performance and 70 °C or larger delta T max, is designed for superior cooling and heating applications. Beyond the standard below, we can design and manufacture the custom made module according to your special requirements.

### Features

- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

### **Performance Specification Sheet**

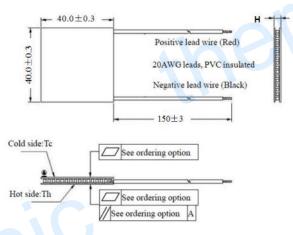
### Application

- Food and beverage service refrigerator
- Portable cooler box for cars
- Liquid cooling
- Temperature stabilizer
- CPU cooler and scientific instrument
- Photonic and medical systems

critici mance specification sheet						
Th (°C)	27	50	Hot side temperature at environment: dry air, N <sub>2</sub>			
DT <sub>max</sub> (°C)	70	79	Temperature Difference between cold and hot side of the module when cooling capacity is zero at cold side			
U <sub>max</sub> (Voltage)	16.0	17.2	Voltage applied to the module at $DT_{max}$			
I <sub>max</sub> (Amps)	5.4	5.4	DC current through the modules at DT <sub>max</sub>			
Q <sub>Cmax</sub> (Watts)	54.1	59.1	Cooling capacity at cold side of the module under DT=0 °C			
AC resistance (Ohms)	2.25	2.45	The module resistance is tested under AC			
Tolerance (%)	± 10		For thermal and electricity parameters			

A. Solder:

### Geometric Characteristics Dimensions in millimeters



### **Manufacturing Options**

**B. Sealant:** 

1.714 minu (711203, winte 7070)	T. Dialik ceraines (not meanized)	
1. Alumina (Al <sub>2</sub> O <sub>3</sub> , white 96%)	1. Blank ceramics (not metalized)	
C. Ceramics:	D. Ceramics Surface Options:	
3. T240: SbSn (Tmelt = 240°C)	3. EPS: Epoxy sealant	
2. T200: CuAgSn (Tmelt = 217°C)	2. SS: Silicone sealant	
1. T100: BiSn (Tmelt=138°C)	1. NS: No sealing (Standard)	

2. Aluminum Nitride (AlN)

2. Metalized

Naming for the Module

### **Ordering Option**

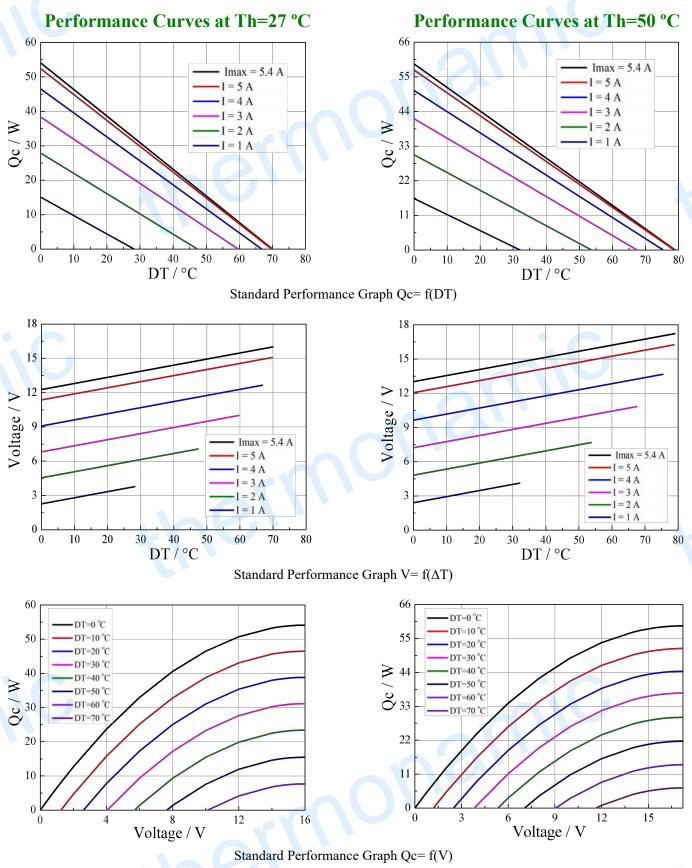
Suffer Thickness Flatness/		Lead wire length (mm)	TEC1-12705- X -X - X - X		
SuffixH / (mm)Parallelism (mm)		Standard/Optional length	TTTLceramics		
TF	0:3.7±0.1	0:0.08/0.08	150±3/Specify	TEC1-12705-T100 -NS -TF01 -AIO	
TF	1:3.7±0.03	1:0.03/0.03	150±3/Specify		
Eg. TF01: Thickness 3.7±0.1(mm) and Flatness 0.03/0.03(mm)				T100: BiSn(Tmelt=138°C)	
				NS: No sealing	AlO: Alumina white 96%

### TF01: Thickness ±0.1(mm) and Flatness/Parallelism(mm): 0.025/0.025

Creative technology with fine manufacturing processes provides you the reliable and quality products. Tel: +86-791-88198288 Fax: +86-791-88198308 Email: <u>sales@thermonamic.com.cn</u> Web Site: www.thermonamic.com.cn

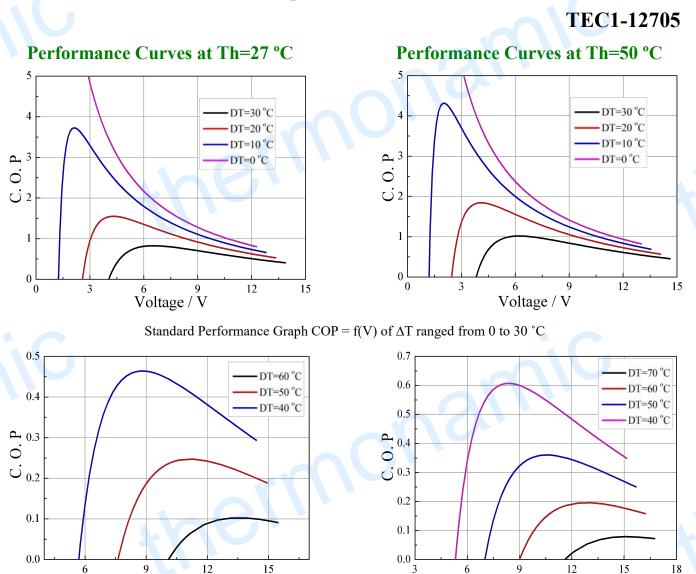
## **Specification of Thermoelectric Module**

### **TEC1-12705**



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Voltage / V



## **Specification of Thermoelectric Module**

Standard Performance Graph COP = f(V) of  $\Delta T$  ranged from 40 to 60/70 °C

Remark: The coefficient of performance (COP) is the cooling power Qc/Input power (V  $\times$  I).

### **Operation Cautions**

- Attach the cold side of module to the object to be cooled
- Attach the hot side of module to a heat radiator for heat dissipating

Voltage / V

- Operation below I<sub>max</sub> or V<sub>max</sub>
- Work under DC